# 承 認 書

## SPECIFICATION FOR APPROVAL

Ewuvqo gt'P co g<	2144	
F guetkr vkqp'Rctv'Pq0<		
Ewwqo gt'Rctv'Pq0		
Uco r ng'P q0 <u>.</u>		
FF[ ''Rctv'Pq0:	UHG5237C/	

DRAWING						
MADE	CHECKED	APPROVED				
王海玲	赵万虎	肖中华				
DATE:	2022年	8月23日				

CUSTOMER APPROVE



## 惠州市德立电子有限公司 HUI ZHOU DE LI ELECTRONICS CO., LTD

廣東省博羅縣洲際工業園梅園三路 NO.3 MEI YUAN ROAD,ZHOU JI INDUSTRIAL AREA,BOLUO COUNTY GUANGDONG

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# HUI ZHOU DE LI ELECTRONICS CO., LTD

Version of Changed Record								
DATE	REV	CHANGED CONTENTS	DRAFT	APPROVED				
2022/8/23	А	新版发行	王海玲	肖中华				
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* Special notes: This product is non-vehicle certified								



### HUI ZHOU DE LI ELECTRONICS CO., LTD

#### 1. Scope

This specification applies to the SFE3015 Series of wire wound SMD power inductor.

(4)

#### 2.PRODUCT IDENTIFICATION

<u>SFE</u> <u>3015</u> □ - <u>1R5</u> □ - □

(3)

- (1)
- (2)
- (5)
- (6) (7)

(1) .Series name (产品品名)

- (2) .Dimensions (产品尺寸)
- (3) .Appearance shape (产品形状)
- (4) .Inductance value (电感值)

A: dodecagon (十二边形): B: octagon (八边形)

1R5: 1.5μH 221: 220μH

(5) Tolerance (误差值)

(6) .Identification code (标识码)

M: ±20%; N: ±30%

(7).Environmental status (环保状态)

LF- Lead free; HF-Halogen free; FP-Free red phosphor.

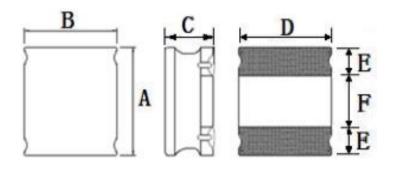
#### 3. Electrical Characteristics

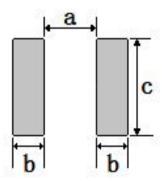
Please refer to Item 5.

- 1). Operating temperature range (individual chip without packing): -40  $^{\circ}\text{C} \sim +125 \,^{\circ}\text{C}$  .
- 2). Storage temperature range (packaging conditions):  $-40^{\circ}$ C  $\sim +85^{\circ}$ C and RH 70% (Max.).
- 3). Rating DC current: Temperature rise( $\triangle$ T) is 40°C approximately at Irms.
- 4). Saturation DC current: Inductance drop approximately 30% of  $L_0$  at Isat.

### 4. Shape and Dimensions (Unit:mm)

shape: A





Recommended Land Pattern

Series	A	В	C	D	Е	F	а Тур.	b Тур.	с Тур.
SFE3015A	3.0±0.2	3.0±0.2	1.5 Max.	2.8±0.2	0.9 Typ.	1.2 Typ.	1.00	1.10	2.7



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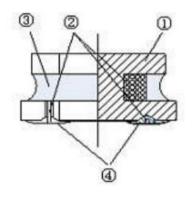
5. E	5. Electrical Characteristics									
		Part Number	Inductance	DC Re	sistance	Isa	t(A)	Irm	ıs(A)	
NO.	DDY CODE	1 art Number	100KHz/1.0V	Max.	Тур.	Max.	Тур.	Max.	Тур.	Marking
		Units	(uH)	Ω	Ω	A	A	A	A	
1		□ SFE3015A-R24N-F-HF	0.24±30%	0.030	0.025	4.50	5.00	4.00	4.50	R24
2		□ SFE3015A-R27N-F-HF	0.27±30%	0.030	0.025	4.20	4.80	3.60	4.00	R27
3		□ SFE3015A-R47N-F-HF	0.47±30%	0.038	0.029	3.50	3.80	3.20	3.60	R47
4		□ SFE3015A-R68N-F-HF	0.68±30%	0.038	0.033	2.80	3.00	2.50	2.80	R68
5		□ SFE3015A-R82N-F-HF	0.82±30%	0.039	0.033	2.60	2.80	2.40	2.60	R82
6		□ SFE3015A-1R0N-F-HF	1.0±30%	0.039	0.035	2.32	2.60	2.35	2.50	1R0
7		□ SFE3015A-1R5N-F-HF	1.5±30%	0.065	0.050	2.30	2.70	1.70	2.20	1R5
8	□ SFE3015A-1R8N-F-HF		1.8±30%	0.065	0.055	1.75	2.20	1.70	2.20	1R8
9	□ SFE3015A-2R2M-F-HF		2.2±20%	0.078	0.064	1.60	2.00	1.60	2.00	2R2
10	□ SFE3015A-3R3M-F-HF		3.3±20%	0.104	0.086	1.32	1.60	1.36	1.60	3R3
11		☐ SFE3015A-4R7M-F-HF	4.7±20%	0.163	0.120	1.10	1.30	1.10	1.20	4R7
12		□ SFE3015A-5R6M-F-HF	5.6±20%	0.180	0.132	1.10	1.20	1.10	1.20	5R6
13	□ SFE3015A-6R8M-F-HF		6.8±20%	0.260	0.200	0.90	1.10	1.10	1.20	6R8
14		□ SFE3015A-8R2M-F-HF	8.2±20%	0.300	0.240	0.80	0.90	1.00	1.00	8R2
15		□ SFE3015A-100M-F-HF	10.0±20%	0.325	0.270	0.77	0.92	0.77	0.80	100
16		□ SFE3015A-150M-F-HF	15.0±20%	0.455	0.390	0.66	0.85	0.66	0.70	150
17		□ SFE3015A-220M-F-HF	22.0±20%	0.598	0.469	0.52	0.65	0.57	0.65	220
18		□ SFE3015A-330M-F-HF	33.0±20%	1.066	0.800	0.45	0.50	0.45	0.50	330
19	□ SFE3015A-470M-F-HF		47.0±20%	1.625	1.195	0.35	0.43	0.35	0.43	470
20		□ SFE3015A-560M-F-HF	56.0±20%	1.664	1.500	0.34	0.40	0.34	0.41	560
21		□ SFE3015A-680M-F-HF	68.0±20%	2.700	1.650	0.28	0.35	0.28	0.31	680
22		□ SFE3015A-820M-F-HF	82.0±20%	3.000	2.300	0.25	0.27	0.25	0.27	820
23		□ SFE3015A-101M-F-HF	100.0±20%	3.900	2.390	0.23	0.25	0.23	0.25	101

※Design as Customer's Requested Specifications. (可按顾客的特殊需求设计)



## HUI ZHOU DE LI ELECTRONICS CO., LTD

## 6. Structure (The structure of product.)



NO	Components	Material
1	Core	Ni-Zn Ferrite
2	Wire	Polyurethane system enameled copper wire
3	Magnetic Glue	Epoxy resin and magnetic powder
4	Plating	AgNiSn or FeNiCu + Sn Alloy

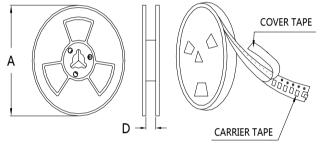
## 7. PACKAGING(unit: mm)

1.包装类型:编带装

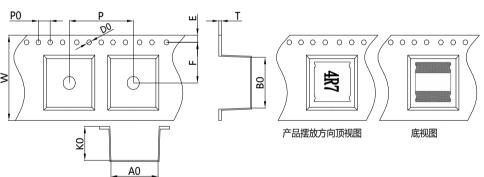
2.包装尺寸:

13" 盘

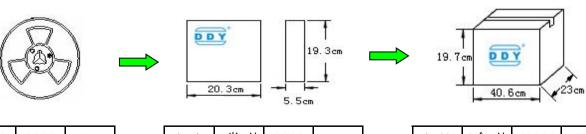
√ 7" 盘



	13" 盘	7" 盘			
Α	Ф330±2.0	Ф178±2.0			
D	8.5				



Item	W	Α0	В0	K0	Р	T	Е	F	D0	Р0
(mm)	8.0 ±0.3	3.3±0.15	3.3±0.15	2.0 ±0.1	4.0±0.1	0.3±0.1	1.75±0.1	3.5 ±0.1	1.5 ±0.1	4.0 ±0.1



每卷 | 2000 | Pcs

每盒 4卷,共 8000 Pcs

每箱 6盒,共 48000 Pcs



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8. RI	ELIABILITY T	EST	
No.	TEST ITEM	SPECIFICATION	TEST CONDITION
1	High temperature Storage test	<ol> <li>No significant defects in appearance.</li> <li>ΔL/L ≤ 10%</li> <li>ΔDCR/DCR ≤ 10%</li> </ol>	Temperature: $125 ^{\circ}\text{C} \pm 5 ^{\circ}\text{C}$ (N: Follow the product specification for the setting.)  Time: $96\pm 2$ hours  Place the samples for one hour at room temperature and test them within two hours
2	Low temperature Storage test	<ol> <li>No significant defects in appearance.</li> <li>ΔL/L ≤ 10%</li> <li>ΔDCR/DCR ≤ 10%</li> </ol>	Temperature: -40°C±5°C (M: Follow the product specification for the setting) Time: 96±2 hours Place the samples for one hour at room temperature and test them within two hours.
3	Humidity test	<ol> <li>No significant defects in appearance.</li> <li>ΔL/L ≤ 10%</li> <li>ΔDCR/DCR ≤ 10%</li> </ol>	Temperature: $40\pm2^{\circ}\text{C}$ , Humidity: $93\pm3^{\circ}\text{RH}$ Time: $96\pm2$ hours Place the samples for one hour at room temperature and test them within two hours
4	Solderability test	Terminals must have 95% minimum solder coverage	1.Dip pads in flux then dip in solder pot at 245±5°C for 5 second. 2.Solder: lead free 3.Flux: rosin flux
5	Heat endurance of flow soldering	<ol> <li>No significant defects in appearance.</li> <li>ΔL/L ≤ 10%</li> <li>ΔDCR/DCR ≤ 10%</li> </ol>	1.Refer to the above reflow curve and go through the reflow for twice. 2.The peak temperature : 260+0/-5℃
6	Vibration test	<ul><li>1.No significant defects in appearance.</li><li>2.No short and no open.</li></ul>	Apply frequency 10~55~10Hz and amplitude 1.5mm, 1 min/cycle in X Y and Z direction for 2 hours each. (total 6 hours)
7	Terminal strength push test	1. Applied force:10N Duration: 10sec 2.Solder paste thickness:0.12mm 3.Meet the above requirements without any loose termina	Solder the test samples to the PCB through245 °C reflow, apply a standard force on the side of the test samples for 10 seconds.



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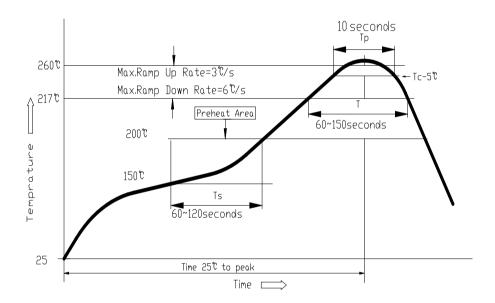
#### 9. SOLDERING CONDITIONS

Applicable soldering process to the products is refl.

#### 9.1 Soldering Materials

- (1) Solder:Sn-3.0Ag-0.5Cu
- (2) Flux:Use rosin-based flux,but not strongly acidic flux (with xhlorine exceeding 0.2wt%).Do not use water-soluble flux.

#### 9.2 Reflow Soldering Profile



#### 9.3 Soldering Iron

Reworking with electric solding iron must preheating at 150°C for 1 minute is required, and do not directly touch the core with the tip of the soldering iron. The reworking soldering conditions are as follows.

- ①Temperature of soldering iron tip:350°C;
- ② Soldering iron power output: ≤30W;
- ③ Diameter of soldering iron end:≤1.0mm;
- **4** Soldering time: ≤3 s

